

# The RF Sub-Micron MOSFET Line

## RF Power Field Effect Transistors

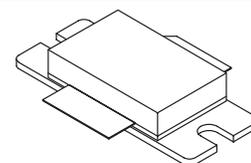
### N-Channel Enhancement-Mode Lateral MOSFETs

**MRF19125**  
**MRF19125S**

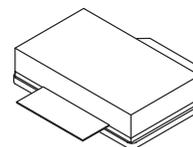
Designed for PCN and PCS base station applications at frequencies from 1.9 to 2.0 GHz. Suitable for TDMA, CDMA and multicarrier amplifier applications.

- Typical 2-Carrier N-CDMA Performance for  $V_{DD} = 26$  Volts,  $I_{DQ} = 1300$  mA,  $f_1 = 1958.75$  MHz,  $f_2 = 1961.25$  MHz IS-95 CDMA (Pilot, Sync, Paging, Traffic Codes 8 Through 13) 1.2288 MHz Channel Bandwidth Carrier. Adjacent Channels Measured over a 30 kHz Bandwidth at  $f_1 - 885$  kHz and  $f_2 + 885$  kHz. Distortion Products Measured over 1.2288 MHz Bandwidth at  $f_1 - 2.5$  MHz and  $f_2 + 2.5$  MHz. Peak/Avg. = 9.8 dB @ 0.01% Probability on CCDF.
  - Output Power — 24 Watts Avg.
  - Power Gain — 13.6 dB
  - Efficiency — 22%
  - ACPR — -51 dB
  - IM3 — -37.0 dBc
- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Ease of Design for Gain and Insertion Phase Flatness
- Capable of Handling 5:1 VSWR, @ 26 Vdc, 1990 MHz, 125 Watts (CW) Output Power
- Excellent Thermal Stability

**1990 MHz, 125 W, 26 V**  
**LATERAL N-CHANNEL**  
**BROADBAND**  
**RF POWER MOSFETs**



**CASE 465B-02, STYLE 1**  
**(MRF19125)**



**CASE 465C-01, STYLE 1**  
**(MRF19125S)**

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	Vdc
Gate-Source Voltage	$V_{GS}$	+15, -0.5	Vdc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	330 1.89	Watts W/ $^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-65 to +200	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	200	$^\circ\text{C}$

#### ESD PROTECTION CHARACTERISTICS

Test Conditions	Class
Human Body Model	2 (Typical)
Machine Model	M3 (Typical)

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.53	$^\circ\text{C}/\text{W}$

NOTE – **CAUTION** – MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Drain–Source Breakdown Voltage ( $V_{GS} = 0\text{ Vdc}$ , $I_D = 100\ \mu\text{Adc}$ )	$V_{(BR)DSS}$	65	—	—	Vdc
Gate–Source Leakage Current ( $V_{GS} = 5\text{ Vdc}$ , $V_{DS} = 0$ )	$I_{GSS}$	—	—	1	$\mu\text{Adc}$
Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 26\text{ Vdc}$ , $V_{GS} = 0$ )	$I_{DSS}$	—	—	10	$\mu\text{Adc}$

**ON CHARACTERISTICS**

Forward Transconductance ( $V_{DS} = 10\text{ Vdc}$ , $I_D = 3\text{ Adc}$ )	$g_{fs}$	—	9	—	S
Gate Threshold Voltage ( $V_{DS} = 10\text{ Vdc}$ , $I_D = 300\ \mu\text{Adc}$ )	$V_{GS(th)}$	2	—	4	Vdc
Gate Quiescent Voltage ( $V_{DS} = 26\text{ Vdc}$ , $I_D = 1300\text{ mAdc}$ )	$V_{GS(Q)}$	2.5	3.9	4.5	Vdc
Drain–Source On–Voltage ( $V_{GS} = 10\text{ Vdc}$ , $I_D = 3\text{ Adc}$ )	$V_{DS(on)}$	—	0.185	0.21	Vdc

**DYNAMIC CHARACTERISTICS**

Reverse Transfer Capacitance (1) ( $V_{DS} = 26\text{ Vdc}$ , $V_{GS} = 0$ , $f = 1\text{ MHz}$ )	$C_{rss}$	—	5.4	—	pF
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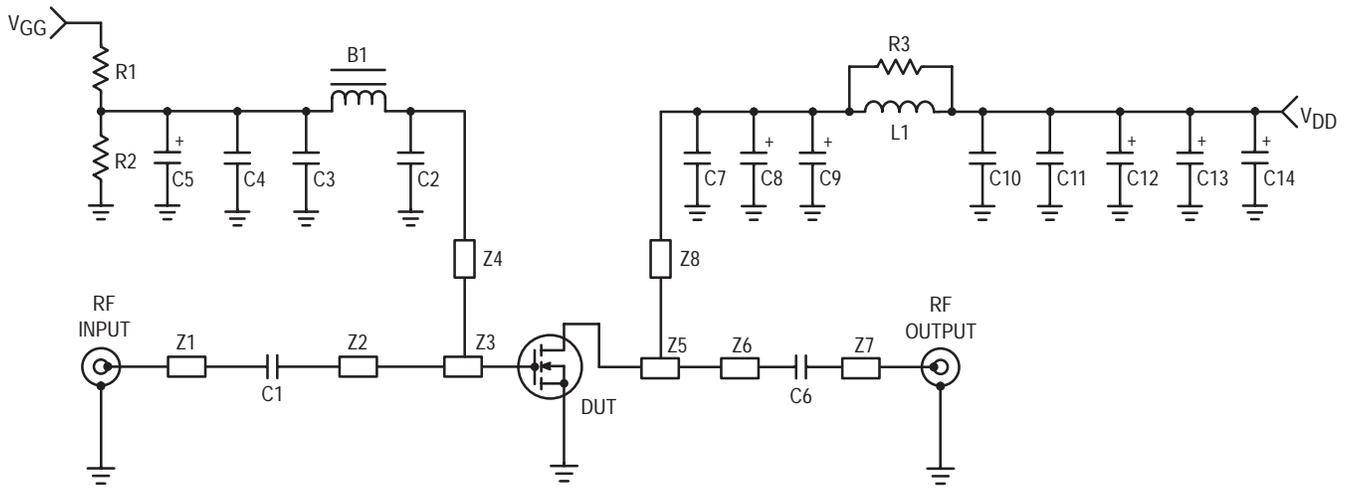
**FUNCTIONAL TESTS** (In Motorola Test Fixture) 2–Carrier N–CDMA, 1.2288 MHz Channel Bandwidth Carriers. Peak/Avg = 9.8 dB @ 0.01% Probability on CCDF.

Common–Source Amplifier Power Gain ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 24\text{ W Avg}$ , $I_{DQ} = 1300\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ )	$G_{ps}$	12	13.5	—	dB
Drain Efficiency ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 24\text{ W Avg}$ , $I_{DQ} = 1300\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ )	$\eta$	19	22	—	%
Intermodulation Distortion ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 24\text{ W Avg}$ , $I_{DQ} = 1300\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ ; IM3 measured over 1.2288 MHz Bandwidth at $f_1 - 2.5\text{ MHz}$ and $f_2 + 2.5\text{ MHz}$ )	IMD	—	–37	–35	dBc
Adjacent Channel Power Ratio ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 24\text{ W Avg}$ , $I_{DQ} = 1300\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ ; ACPR measured over 30 kHz Bandwidth at $f_1 - 885\text{ MHz}$ and $f_2 + 885\text{ MHz}$ )	ACPR	—	–51	–47	dBc
Input Return Loss ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 24\text{ W Avg}$ , $I_{DQ} = 1300\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1932.5\text{ MHz}$ and $f_1 = 1987.5\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ )	IRL	—	–13	–9	dB
Output Mismatch Stress ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 125\text{ W CW}$ , $I_{DQ} = 1300\text{ mA}$ , $f = 1930\text{ MHz}$ , VSWR = 5:1, All Phase Angles at Frequency of Test)	$\Psi$	No Degradation In Output Power Before and After Test			

(1) Part is internally matched both on input and output.

**ELECTRICAL CHARACTERISTICS — continued** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>FUNCTIONAL TESTS</b> (In Motorola Test Fixture)					
Two-Tone Common-Source Amplifier Power Gain ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 125\text{ W PEP}$ , $I_{DQ} = 1300\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ , Tone Spacing = 100 kHz)	$G_{ps}$	—	13.5	—	dB
Two-Tone Drain Efficiency ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 125\text{ W PEP}$ , $I_{DQ} = 1300\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ , Tone Spacing = 100 kHz)	$\eta$	—	35	—	%
Third Order Intermodulation Distortion ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 125\text{ W PEP}$ , $I_{DQ} = 1300\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ , Tone Spacing = 100 kHz)	IMD	—	-30	—	dBc
Input Return Loss ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 125\text{ W PEP}$ , $I_{DQ} = 1300\text{ mA}$ , $f_1 = 1930\text{ MHz}$ , $f_2 = 1990\text{ MHz}$ , Tone Spacing = 100 kHz)	IRL	—	-13	—	dB
$P_{out}$ , 1 dB Compression Point ( $V_{DD} = 26\text{ Vdc}$ , $I_{DQ} = 1300\text{ mA}$ , $f = 1990\text{ MHz}$ )	P1dB	—	130	—	W



Z1, Z7	0.500" x 0.084" Transmission Line	Board	0.030" Glass Teflon®,
Z2	1.105" x 0.084" Transmission Line	PCB	Keene GX-0300-55-22, $\epsilon_r = 2.55$
Z3	0.360" x 0.895" Transmission Line		Etched Circuit Boards
Z4	0.920" x 0.048" Transmission Line		MRF19125 Rev. 5, CMR
Z5	0.605" x 1.195" Transmission Line		
Z6	0.800" x 0.084" Transmission Line		
Z8	0.660" x 0.095" Transmission Line		

**Figure 1. MRF19125 Test Circuit Schematic**

**Table 1. MRF19125 Component Designations and Values**

Designators	Description
B1	Short Ferrite Bead, Fair Rite, #2743019447
C1	51 pF Chip Capacitor, ATC #100B510JCA500X
C2, C7	5.1 pF Chip Capacitors, ATC #100B5R1JCA500X
C3, C10	1000 pF Chip Capacitors, ATC #100B102JCA500X
C4, C11	0.1 $\mu$ F Chip Capacitors, Kemet #CDR33BX104AKWS
C5	0.1 $\mu$ F Tantalum Chip Capacitor, Kemet #T491C105M050
C6	10 pF Chip Capacitor, ATC #100B100JCA500X
C8	10 $\mu$ F Tantalum Chip Capacitor, Kemet #T491X106K035AS4394
C9, C12, C13, C14	22 $\mu$ F Tantalum Chip Capacitors, Kemet #T491X226K035AS4394
L1	1 Turn, #20 AWG, 0.100" ID, Motorola
N1, N2	Type N Flange Mounts, Omni Spectra #3052-1648-10
R1	1.0 k $\Omega$ , 1/8 W Chip Resistor
R2	220 k $\Omega$ , 1/8 W Chip Resistor
R3	10 $\Omega$ , 1/8 W Chip Resistor

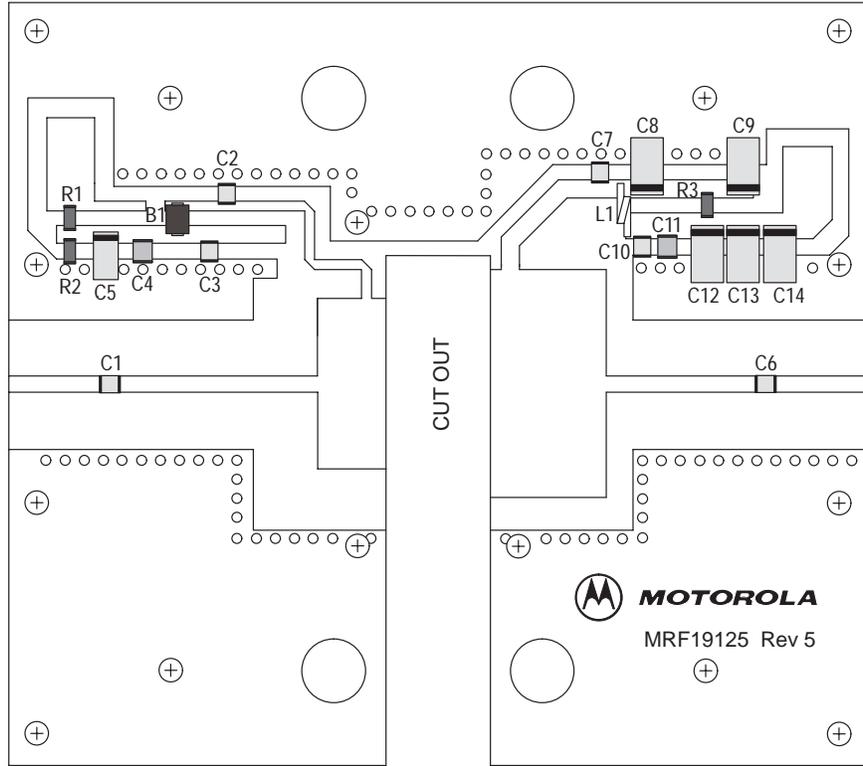
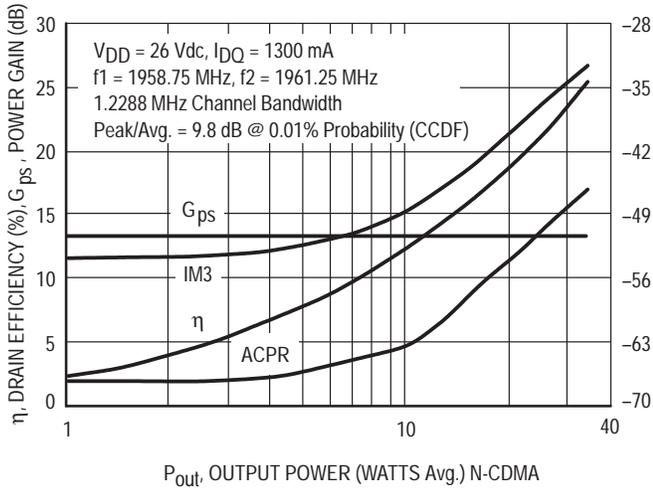
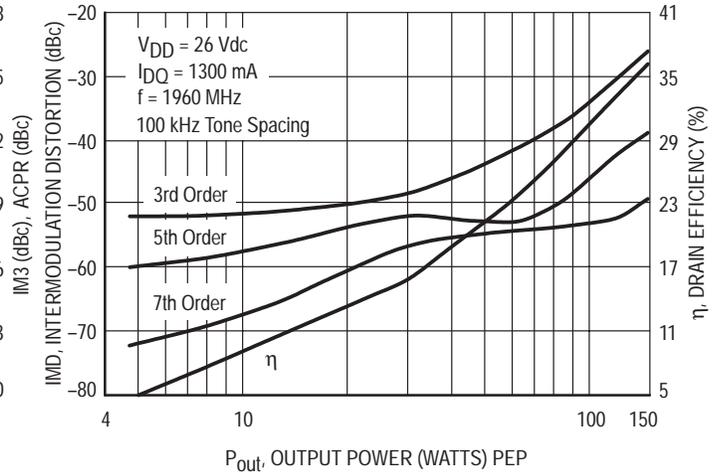


Figure 2. MRF19125 Test Circuit Component Layout

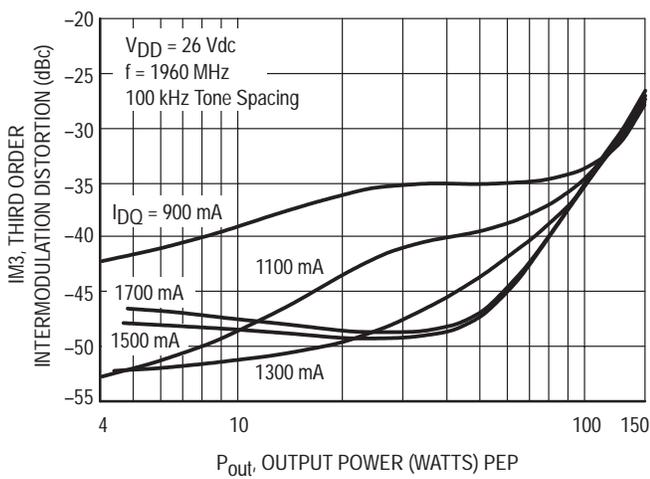
## TYPICAL CHARACTERISTICS



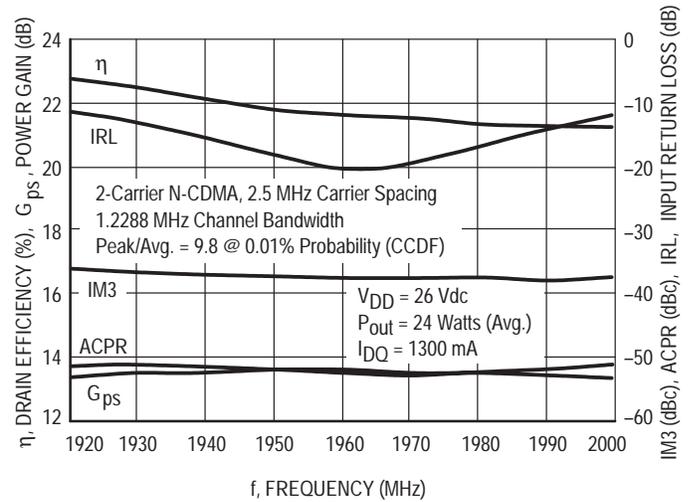
**Figure 3. 2-Carrier CDMA ACPR, IM3, Power Gain and Drain Efficiency versus Output Power**



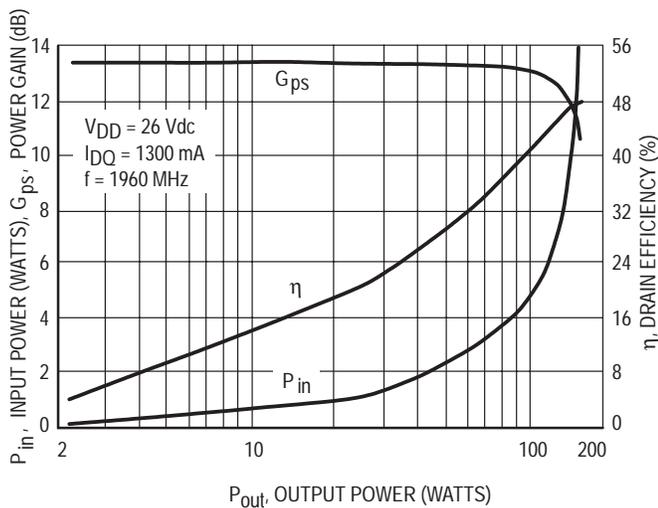
**Figure 4. Intermodulation Distortion Products versus Output Power**



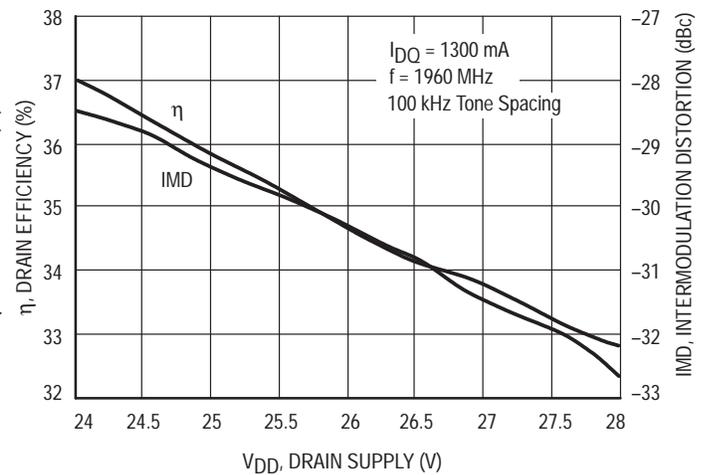
**Figure 5. Third Order Intermodulation Distortion versus Output Power**



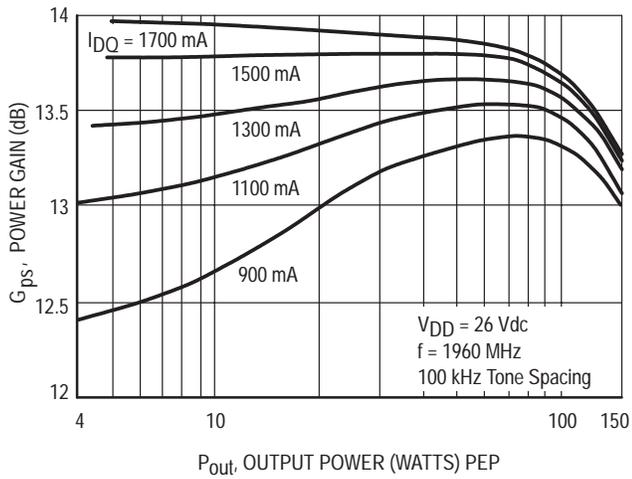
**Figure 6. 2-Carrier N-CDMA Broadband Performance**



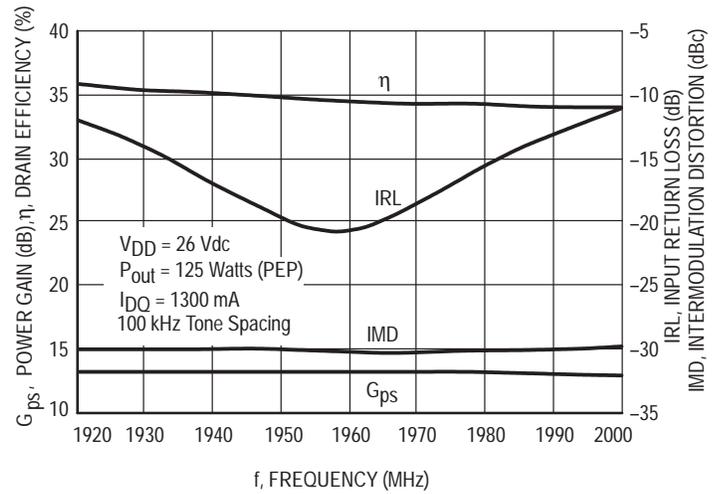
**Figure 7. CW Performance**



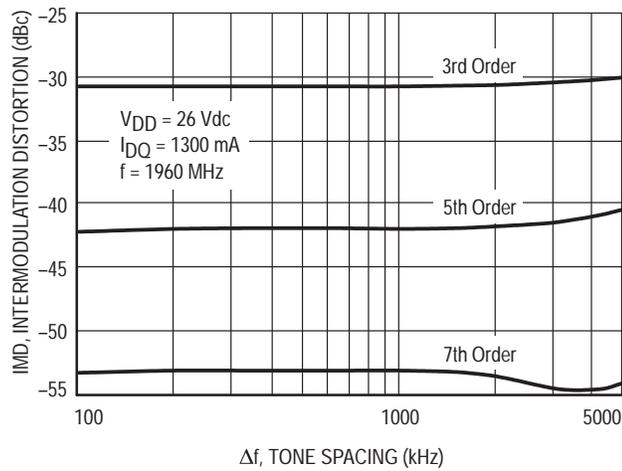
**Figure 8. Two-Tone Intermodulation Distortion and Drain Efficiency versus Drain Supply**



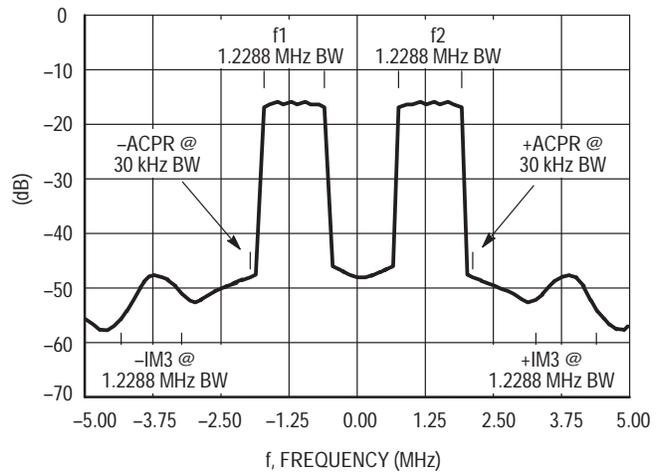
**Figure 9. Two-Tone Power Gain versus Output Power**



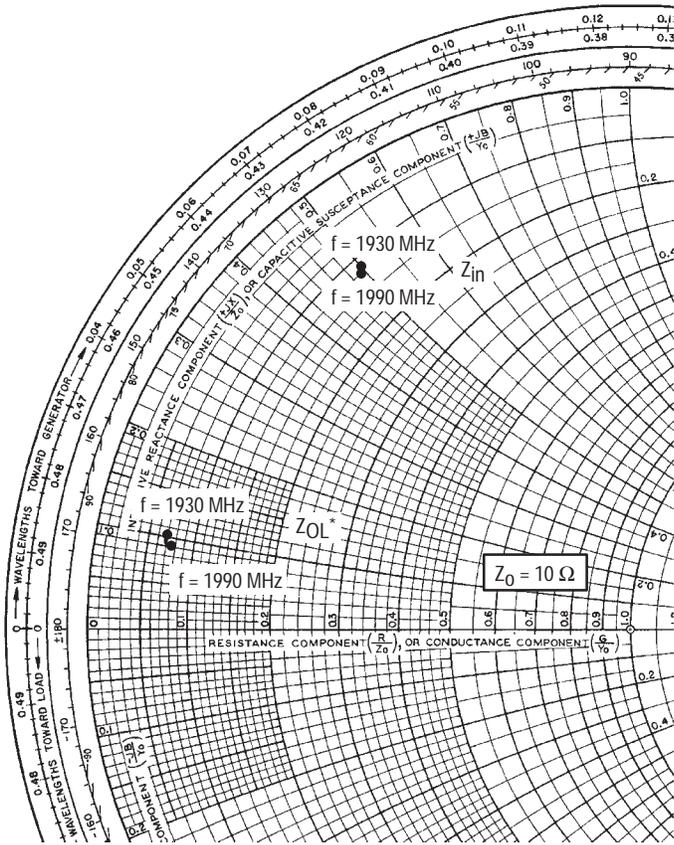
**Figure 10. Two-Tone Broadband Performance**



**Figure 11. Intermodulation Distortion Products versus Two-Tone Tone Spacing**



**Figure 12. 2-Carrier N-CDMA Spectrum**



$V_{DD} = 26\text{ V}$ ,  $I_{DQ} = 1300\text{ mA}$ ,  $P_{out} = 24\text{ W (Avg.)}$

f MHz	$Z_{in}$ $\Omega$	$Z_{OL}^*$ $\Omega$
1930	$1.43 + j5.01$	$0.75 + j0.93$
1960	$1.51 + j4.88$	$0.71 + j0.89$
1990	$1.56 + j4.93$	$0.68 + j1.02$

$Z_{in}$  = Complex conjugate of source impedance.

$Z_{OL}^*$  = Complex conjugate of the optimum load impedance at a given output power, voltage, IMD, bias current and frequency.

Note:  $Z_{OL}^*$  was chosen based on tradeoffs between gain, output power, drain efficiency and intermodulation distortion.

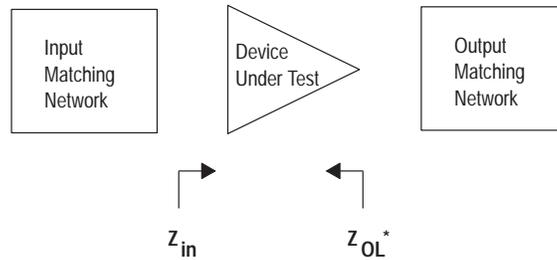
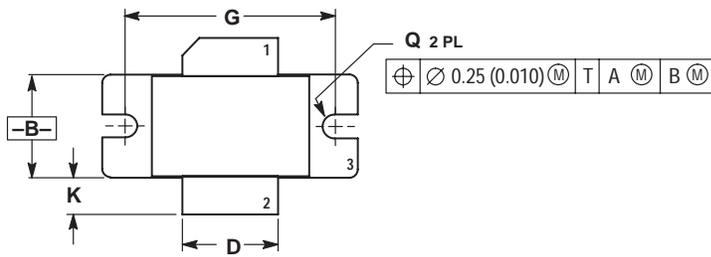


Figure 13. Series Equivalent Input and Output Impedance

# NOTES

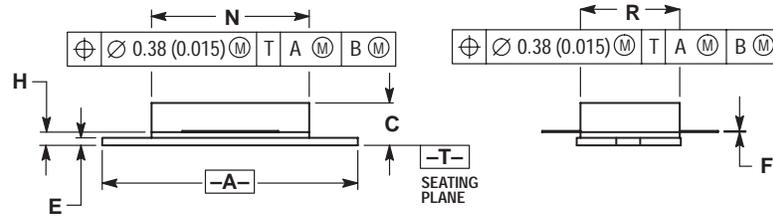
# NOTES

## PACKAGE DIMENSIONS



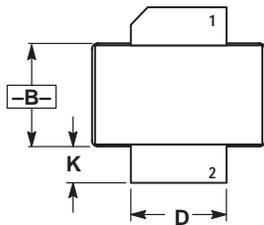
- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.  
 3. DIMENSION H IS MEASURED 0.030" AWAY FROM FLANGE.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.335	1.345	33.91	34.16
B	0.535	0.545	13.6	13.8
C	0.155	0.200	3.94	5.08
D	0.495	0.505	12.57	12.83
E	0.035	0.045	0.89	1.14
F	0.003	0.006	0.08	0.15
G	1.100 BSC		27.94 BSC	
H	0.057	0.067	1.45	1.70
K	0.170	0.210	4.32	5.33
N	0.871	0.889	19.30	22.60
Q	0.118	0.138	3.00	3.51
R	0.515	0.525	13.10	13.30



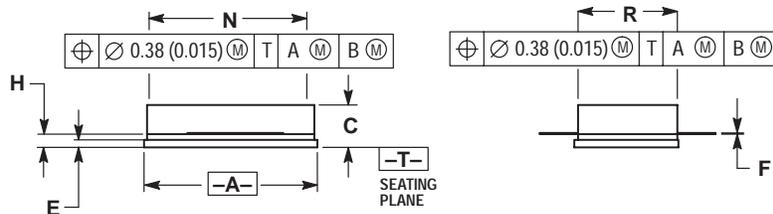
- STYLE 1:  
 PIN 1. DRAIN  
 2. GATE  
 3. SOURCE

**CASE 465B-02  
 ISSUE A  
 (MRF19125)**



- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.  
 3. DIMENSION H IS MEASURED 0.030" AWAY FROM FLANGE.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.905	0.915	22.99	23.24
B	0.535	0.545	13.6	13.8
C	0.155	0.200	3.94	5.08
D	0.495	0.505	12.57	12.83
E	0.035	0.045	0.89	1.14
F	0.003	0.006	0.08	0.15
H	0.057	0.067	1.45	1.70
K	0.170	0.210	4.32	5.33
N	0.871	0.889	19.30	22.60
R	0.515	0.525	13.10	13.30



- STYLE 1:  
 PIN 1. DRAIN  
 2. GATE  
 3. SOURCE

**CASE 465C-01  
 ISSUE O  
 (MRF19125S)**

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